# mail

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### FDD390N15A N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 26 A, 40 m $\Omega$

#### Features

- +  $R_{DS(on)}$  = 33.5 m $\Omega$  ( Typ.)@  $V_{GS}$  = 10 V, I<sub>D</sub> = 26 A
- · Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 14.3 nC( Typ.)
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### Applications

- Consumer Appliances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			FDD390N15A	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		150	V		
V	Gata to Source Voltage	- DC		±20	V	
VGSS	Gale to Source voltage	- AC (	f > 1 Hz)	±30	v	
L	Brain Current	- Continuous (T <sub>C</sub> = 25°C,Silicon Limited)		26	٨	
D	Drain Gurrent	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C,Silicon Lin	17	~		
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	104	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			78	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	6.0	V/ns	
D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		63	W	
гD	Power Dissipation	- Derate above 25°C		0.5	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

#### **Thermal Characteristics**

Symbol	Parameter	FDD390N15A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	87	

Part Nur	nber	Top Mark Packag		Packing Method Reel Size		Tape W	lidth	Quant	tity
FDD390N15A FDD390N15A DPAK		DPAK	Tape and Reel	330 mm	16 mm		2500 units		
Electrica	I Char	•acteristics ⊤ <sub>c</sub> =	25°C unless	otherwise noted					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		oltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$		150	-	-	V
ΔΒV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakd Coeffic	Breakdown Voltage Temperature		$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.1	-	V/°C
	Zero G	ate Voltage Drain Curr	ent	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V		-	-	1	
USS	2010 0	Zero Gale Vollage Drain Current		$V_{DS} = 120 V, T_{C} = 125^{\circ}C$		-	-	500	μΛ
I <sub>GSS</sub>	Gate to	Body Leakage Curren	nt	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} =$	0 V	-	-	±100	nA
On Charac	teristic	S							
V <sub>GS(th)</sub>	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$		2.0	-	4.0	V
R <sub>DS(on)</sub>	Static D	Drain to Source On Res	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 26 \text{ A}$		-	33.5	40	mΩ
9 <sub>FS</sub>	Forwar	d Transconductance		$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 26 \text{ A}$			33	-	S
Dynamic C	haract	eristics							
Ciss	Input C	apacitance				-	965	1285	pF
C <sub>oss</sub>	Output	Capacitance		──V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V ──f = 1 MHz		-	96	130	pF
C <sub>rss</sub>	Revers	e Transfer Capacitance	Э			-	5.8	-	pF
C <sub>oss(er)</sub>	Energy	Energy Related Output Capacitance		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$			169	-	pF
Q <sub>g(tot)</sub>	Total G	ate Charge at 10V				- 1	14.3	18.6	nC
Q <sub>gs</sub>	Gate to	Source Gate Charge		$V_{DS} = 75 \text{ V}, \text{ I}_{D} = 27 \text{ A}$ $V_{GS} = 10 \text{ V}$ (Note 4)			5.0	-	nC
Q <sub>gs2</sub>	Gate C	harge Threshold to Pla	iteau			-	2.0	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge				-	3.5	-	nC
ESR	Equival	ent Series Resistance	(G-S)	f = 1 MHz		-	1.4	-	Ω
Switching	Charac	teristics							
t <sub>d(on)</sub>	Turn-O	n Delay Time		$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 27 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 4.7 \Omega$ (Note 4)		-	14	38	ns
t <sub>r</sub>	Turn-O	n Rise Time				-	10	30	ns
t <sub>d(off)</sub>	Turn-Of	ff Delay Time				-	20	50	ns
t <sub>f</sub>	Turn-Of	f Fall Time				- /	5	20	ns
Drain-Sou	rce Dio	de Characteristic	S					1	
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current			-	-	26	Α		
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo			orward Current		-	-	104	Α
V <sub>SD</sub>	Drain to	Source Diode Forward	d Voltage	ve V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 26 A		-	-	1.25	V
t <sub>rr</sub>	Reverse	e Recovery Time		$V_{GS} = 0 V, I_{SD} = 27 A, V_{DD} = 75 V$ dI <sub>F</sub> /dt = 100 A/ $\mu$ s		-	63	-	ns
0	Reverse	e Recovery Charge				-	131	-	nC

4. Essentially Independent of Operating Temperature Typical Characteristics



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